

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2022 to Q4/2023

Based on structural similarity

| Supplier  |                             | User Part Number                                    |             |            |            |           |  |
|---|-----------------------------|---|-------------|------------|------------|-----------|--|
| Nexperia B.V.   |                             | PMEG45T20EXD-Q                                      |             |            |            |           |  |
| Name of Laboratory  Assembly reliability labs  Based on AEC-Q101 Test |                             | Part Description                                    |             |            |            |           |  |
|   |                             | Nexperia DHAM                                       |             |            |            |           |  |
|   |                             | SMD package   |             |            |            |           |  |
|   |                             | Test Conditions                                     | Duration    | # Lots     | # Quantity | # Rejects |  |
|   | TEST                        |   |             |            |            |           |  |
|   | Pre- and Post-Stress        |   |             |            |            |           |  |
| # E1  | Electrical Test             | Tamb = 25 °C  | N/A         | see below  | all parts  | see below |  |
|   |                             | JESD22-A113   |             |            |            |           |  |
|   |                             | Bake Tamb = 125 °C                                  | 24 hours    |            |            |           |  |
|   | PC                          | Soak Tamb = 85 °C, RH = 85%                         | 168 hours   |            |            |           |  |
| # A1  | Preconditioning             | Reflow soldering                                    | 3 cycles    | 1514       | 64430      | 0         |  |
|   |                             | MIL-STD-750-1                                       |             |            |            |           |  |
|   | HTRB                        | M1038 Method A                                      |             |            |            |           |  |
|   | High Temperature Reverse    | Tj = Tjmax, Vr = 100% of max. datasheet             |             |            |            |           |  |
| # B1  | Bias                        | reverse voltage <sup>[1]</sup>                      | 1000 hours  | 206        | 9320       | 0         |  |
|   |                             |   |             |            |            |           |  |
|   | TC                          | JESD22-A104   |             |            |            |           |  |
| # A4  | Temperature Cycling         | -65 °C to Tjmax, not to exceed 150°C                | 1000 cycles | 311        | 14080      | 0         |  |
|   |                             | JECD33 A110   |             |            |            |           |  |
| # A3 <b>or</b>  | UHAST<br>Unbiased HAST      | JESD22-A118<br>Tamb = 130 °C, RH = 85 %             |             |            |            |           |  |
| + A3 <b>01</b>  | Olibiased FIAST             | · · · · · · · · · · · · · · · · · · ·               | - 96 hours  | 311        | 14080      | 0         |  |
|   |                             | JESD22-A102   |             |            |            |           |  |
|   | AC                          | Tamb = 121 °C, RH = 100 %                           |             |            |            |           |  |
| # A3 alt  | Autoclave                   | Pressure = 205 kPa (29.7 psia)                      |             |            |            |           |  |
|   | H3TRB                       | JESD22-A101   |             |            |            |           |  |
|   | High Humidity High          | Tamb = 85 °C, RH = 85%, VR = 80 % of                |             |            |            |           |  |
| # A2 alt  |                             | rated reverse voltage <sup>[1], [2]</sup>           | 1000 hours  | 311        | 14080      | 0         |  |
| # A2 alt  | remperature Reverse Dias    |   | 1000 Hours  | 311        | 14000      | U         |  |
|   | IOL                         | MIL-STD-750 Method 1037                             |             |            |            |           |  |
| # A5  | Intermittent Operating Life | ton = toff, devices powered to insure $\Delta Tj$ = | 1000 hours  | 312        | 14120      | 0         |  |
| + A3  | intermittent Operating Life | 100 C 101 13000 cycles                              | 1000 Hours  | 312        | 14120      | U         |  |
|   | RSH                         | JESD22-A111   |             |            |            |           |  |
| # C8  | Resistance to Solder Heat   |   | 10 s        | 269        | 8070       | 0         |  |
| 7 00  | SD                          | 200 0 = 3 0   | 10.5        | 203        | 0070       | U         |  |
| # C10   | Solderability               | J-STD-002   |             | 222        | 6660       | 0         |  |
| - C10   | Joiderability               | 3 310 002   |             | <b>LLL</b> | 0000       | U         |  |

<sup>[1]</sup> The physical limitations of Schottky diodes have to be considered (thermal runaway).

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|------------|----------|---------|--------------------|------------|
| Nexperia  |            |          |         |                    |            |
| DHAM      | Schottky   | 9320     | 0       | 0,46               | 2,19E+09   |

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<sup>[2]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.